

1. General Specifications

Operating Temp.	:	min20°C ~max. 70°C				
Storage Temp.	:	min30°C ~max. 85°C				
Dot Pixels	:	128 (W) × 64 (H) dots				
Dot Size	:	0.48 (W) × 0.48 (H) mm				
Dot Pitch	:	0.50 (W) × 0.50 (H) mm				
Viewing Area	:	66.8 (W) × 35.5 (H) mm				
Outline Dimensions	:	89.7 (W) × 49.8* (H) × 6.0 (D) mm * Without FPCUV				
Weight		33.0g max.				
5	•					
LCD Type	:	NTD-21558 (STN / Blue-mode / Transmissive)				
C C	:					
LCD Type	:	(STN / Blue-mode / Transmissive)				
LCD Type Viewing Angle	:	 (STN / Blue-mode / Transmissive) 6:00 8-bit parallel data transfer Serial data transfer 				

2.Electrical Specifications

2.1. Absolute Maximum Ratings

		3	G	ND=0V	
Parameter	Symbol	Conditions	Min.	Max.	Units
Supply Voltage	Vdd-GND	-	-0.3	7.0	V
(Logic)					
Supply Voltage	Vdd-GND	-	-6.0	+0.3	V
(Booster Circuit)					
Supply Voltage 1	V5, Vout	-	-18.0	+0.3	V
(LCD Drive)					
Input Voltage	Vin	_	-0.3	Vdd+0.3	V

2.2. DC Characteristics

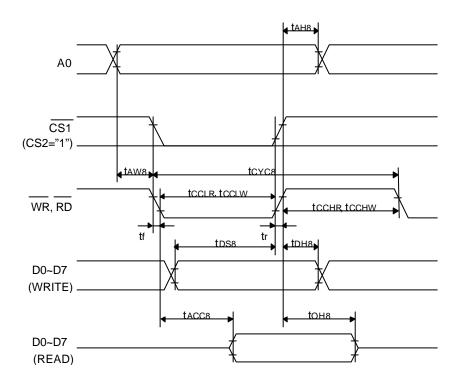
Ta=25°C, GND=0V

					Ta=25°C, G	ND=0V
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Units
Supply Voltage (Logic)	Vdd-GND	With Triple	4.5	-	5.5	V
Supply Voltage (LCD Drive)	Vdd-V5		Shown in 3.	1		V
"High" Level Input Voltage	Viн	-	0.8×Vdd	-	Vdd	V
"Low" Level Input Voltage	Vil	-	GND	-	0.2×Vdd	V
"High" Level Output Voltage	Vон	юн=-0.1mA	0.8×Vdd	-	Vdd	V
"Low" Level Output Voltage	Vol	lol=0.1mA	GND	-	0.2×Vdd	V
Supply Current	lod	Vdd-GND=5.0V	-	0.84	1.26	mA

2.3.AC Characteristics

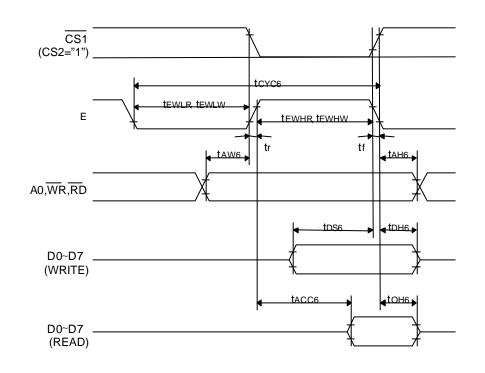
2.3.1.Read/Write Operation Sequence (80 series CPU)

VDD=5.0V±109						
Parameter		Symbol	Min.	Max.	Units	
Address Setup Time		t _{AW8}	0	-	ns	
Address Hold Time		t _{AH8}	0	-	ns	
System Cycle Time		t _{CYC8}	166	-	ns	
Control Low Pulse Width	WRITE	t _{CCLW}	30	-	ns	
	READ	t _{CCLR}	70	-	ns	
Control High Pulse Width	WRITE	t _{сснw}	30	-	ns	
	READ	t _{CCHR}	30	-	ns	
Data Setup Time		t _{DS8}	30	-	ns	
Data Hold Time		t _{DH8}	10	-	ns	
RD Access Time		t _{ACC8}	-	70	ns	
Output Disable Time		t _{OH8}	5	50	ns	



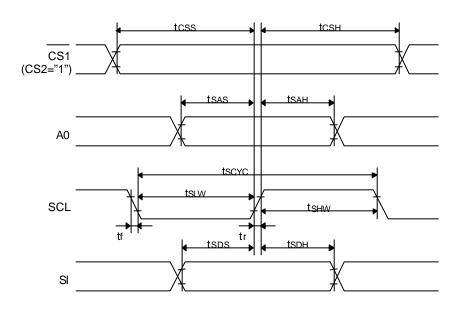
2.3.2. Read/Write Ope	ration Sequence	(68	series	CPU)
				U . U ,

				Vdd	=5.0V±10%
Parameter		Symbol	Min.	Max.	Units
Address Setup Time		t _{AH6}	0	-	ns
Address Hold Time		t _{AW6}	0	-	ns
System Cycle Time		t _{CYC6}	166	-	ns
Data Setup Time		\mathbf{t}_{DS6}	30	-	ns
Data Hold Time		t _{DH6}	10	-	ns
Access Time (CL=100pF)		t _{ACC6}	-	70	ns
Output Disable Time		t₀ _{H6}	10	50	ns
Enable High Pulse Width	READ	t ewhr	70	-	ns
	WRITE	t ewhw	30	-	ns
Enable Low Pulse Width	READ	t _{EWLR}	30	-	ns
	WRITE	t _{EWLW}	30	-	ns



2.3.3. Serial Interface Sequence

Vdd=5.0±					
Parameter	Symbol	Min.	Max.	Units	
Serial Clock Cycle Time	t _{scyc}	200	-	ns	
Serial Clock High Pulse Width	t _{sнw}	75	-	ns	
Serial Clock Low Pulse Width	t _{sLW}	75	-	ns	
Address Setup Time	t _{sas}	50	-	ns	
Address Hold Time	t _{sah}	100	-	ns	
Data Setup Time	t _{sDS}	50	-	ns	
Data Hold Time	t _{sdh}	50	-	ns	
Chip Select Setup Time	t _{css}	100	-	ns	
Chip Select Hold Time	t _{csн}	100	-	ns	

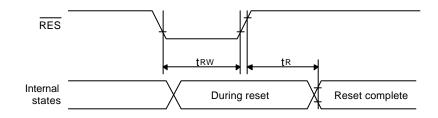


2.3.4. Display Control Timing Characteristics

Reset Input Timing VDD=5.0±10							
Parameter	Symbol	Min.	Тур.	Max.	Units		
Reset time	t _R	-	-	0.5			
Reset "L" Pulse Width	t _{RW}	0.5	-	-	μs		

Output Timing	Vdd=5.0±10%					
Parameter	Symbol	Min.	Тур.	Max.	Units	
FR Delay Time	t _{DFR}	-	10	40	ns	

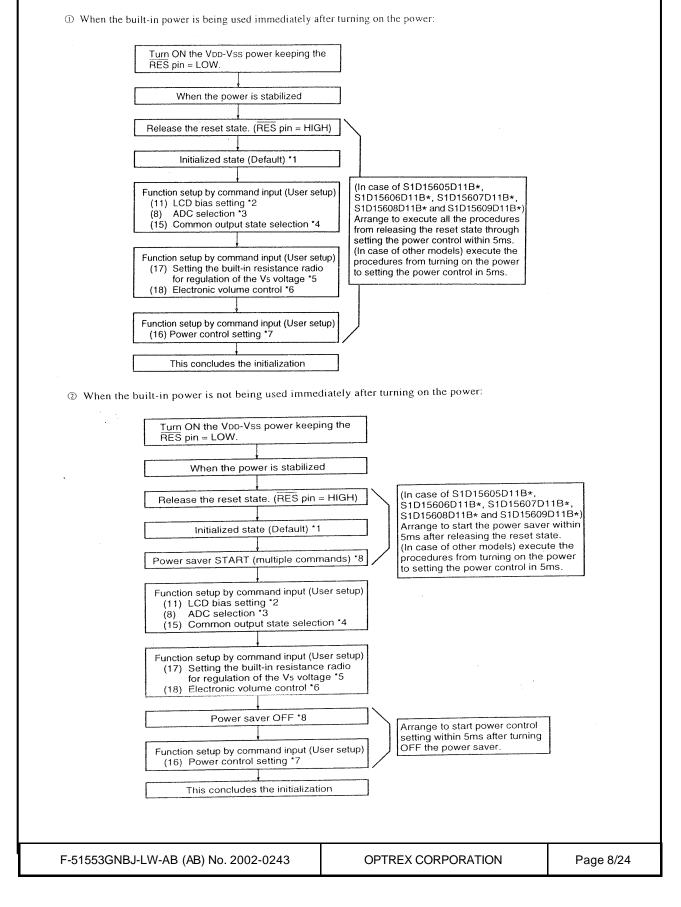
Note 1 :Valid only when the master mode is selected. Note 2:All timing is based on 20% and 80% of Vss.



Instruction Setup: Reference (reference)

(1) Initialization

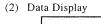
Note: With this IC, when the power is applied, LCD driving non-selective potentials V₂ and V₃ (SEG pin) and V₁ and V₄ (COM pin) are output through the LCD driving output pins SEG and COM. When electric charge is remaining in the smoothing capacitor connecting between the LCD driving voltage output pins (V₁ ~ V₅) and the VDD pin, the picture on the display may become totally dark instantaneously when the power is turned on. To avoid occurrence of such a failure, we recommend the following flow when turning on the power.

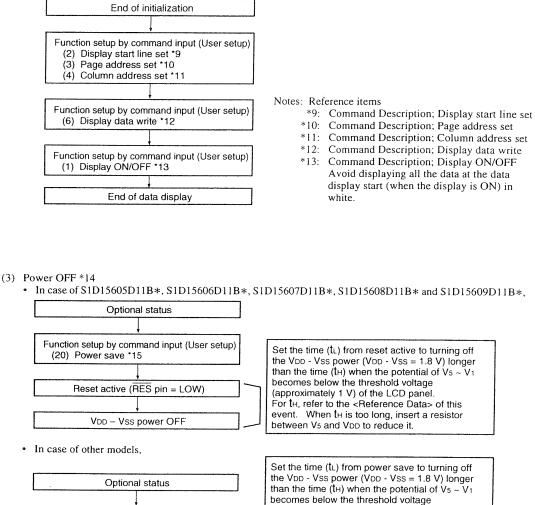


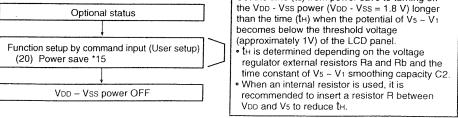
* The target time of 5ms will result to vary depending on the panel characteristics and the capacitance of the smoothing capacitor. Therefore, we suggest you to conduct an operation check using the actual equipment.

Notes: Refer to respective sections or paragraphs listed below.

- *1: 6. Description of functions; "Resetting circuit" (The contents of DDRAM can be variable even in the initial setting (Default) at the reset state.)
- *2: 7. Command description; "(11) LCD bias setting"
- *3: 7. Command description; "(8) ADC selection'
- *4: 7. Command description; "(15) Common output state selection"
- *5: 6. Description of functions; "Power circuit" & "(17) Command description; Setting the built-in resistance radio for regulation of the V5 voltage'
- *6: 6. Description of functions; "Power circuit" & "(18) Command description; Electronic volume control"
 *7: 6. Description of functions; "Power circuit" & "(16) Command description; Power control setting" *8: 7. The power saver ON state can either be in sleep state or stand-by state.
- Command description; "Power saver START (multiple commands)"





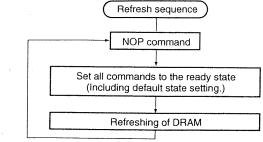


Notes: Reference items

*14: The logic circuit of this IC's power supply VDD - Vss controls the driver of the LCD power supply VDD - V5. So, if the power supply VDD - VSS is cut off when the LCD power supply VDD - V5 has still any residual voltage, the driver (COM. SEG) may output any uncontrolled voltage. When turning off the power, observe the following basic procedures: After turning off the internal power supply, make sure that the potential V5 ~ V1 has become below the threshold voltage of the LCD panel, and then turn off this IC's power supply (VDD - VSS). 6. Description of Function, 6.7 Power Circuit *15: After inputting the power save command, be sure to reset the function using the RES terminal until the power supply VDD - VSS is turned off. 7. Command Description (20) Power Save After inputting the power save command, do not reset the function using the RES terminal until the power supply VDD - VSS is turned off. 7. Command Description (20) Power Save *16 F-51553GNBJ-LW-AB (AB) No. 2002-0243 OPTREX CORPORATION Page 9/24

(4) Refresh

It is recommended that the operating modes and display contents be refreshed periodically to prevent the effect of unexpected noise.



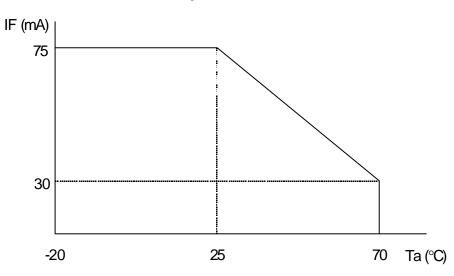
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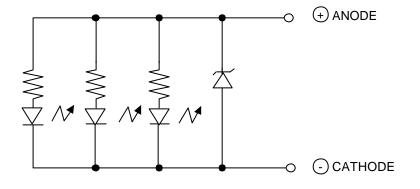
2.4. Lighting Specifications

2.4.1. Absolute Maximum Ratings

	Ũ				Ta=25°	C (1Unit)
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Units
Foward Current	ŀF	Note 1	-	-	75	mA
Reverse Voltage	Vr	-	-	-	8	V
LED Power Dissipation	PD	-	-	-	0.375	W

Note 1 : Refer to the foward current derating curve.





2.4.2. Operating Characteristics

	-						Ta=25°C	
Parameter	Symbol	Co	onditions	Min.	Тур.	Max.	Units	
Foward Voltage	Vf	IF	=40mA	-	5.0	-	V	
Luminance of	L	l⊧=40mA		65	100	-	cd/m ²	
Backlight Surface								
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3. Optical Specifications

3.1.LCD Driving Voltage

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Units
Recommended		Ta= -20°C	-	-	9.1	V
LCD Driving Voltage	Vdd-V5	Ta=25°C	7.8	8.5	9.1	V
Note 1		Ta=70°C	7.4	-	-	V

Note 1 : Voltage (Applied actual waveform to LCD Module) for the best contrast. The range of minimum and maximum shows tolerance of the operating voltage. The specified contrast ratio and response time are not guaranteed over the entire range.

3.2. Optical Characteristics

Ta=25°C, 1/65 Duty, 1/7 Bias, Vop=8.5V (Note 4), θ= 0°, φ= - °

Parameter		Symbol	Conditions	Min.	Тур.	Max.	Units
Contrast Ra	atio Note 1	CR	θ= 0°, φ= - °	-	8	-	
Viewing Angle			Shown in 3.3				
Response	Rise Note 2	Ton	-	-	160	240	ms
Time	Decay Note 3	Toff	-	-	190	290	ms

Note 1 :Contrast ratio is definded as follows. (CR = LON / LOFF)

LON : Luminance of the ON segments

LOFF: Luminance of the OFF segments

Mesuring Spot : 3mm

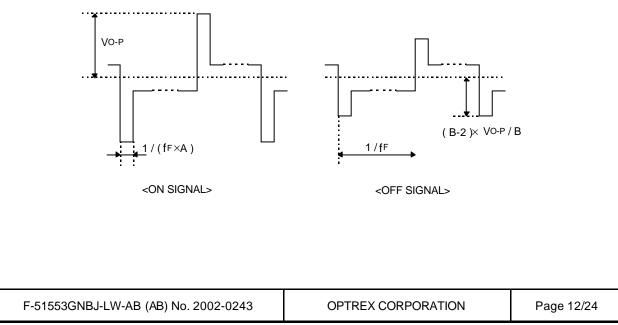
Note 2 :The time that the luminance level reaches 90% of the saturation level from 0% when ON signal is applied.

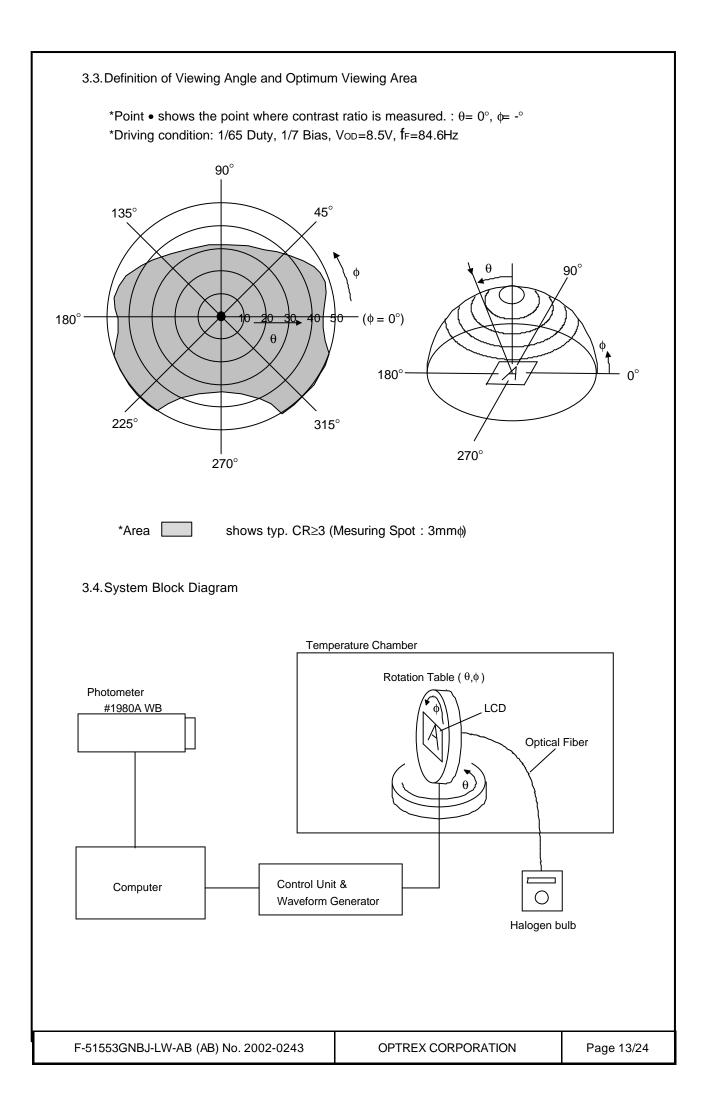
Note 3 :The time that the luminance level reaches 10% of the saturation level from 100% when OFF signal is applied.

Note 4 :Definition of Driving Voltage VoD

VOD=VCC-VADJ-VBE

Assuming that the typical driving waveforms shown below are applied to the LCD Panel at 1/A Duty - 1/B Bias (A: Duty Number, B: Bias Number). Driving voltage VoD is definded as the voltage VO-P when the contrast ratio (CR=LON / LOFF) is at its maximum.



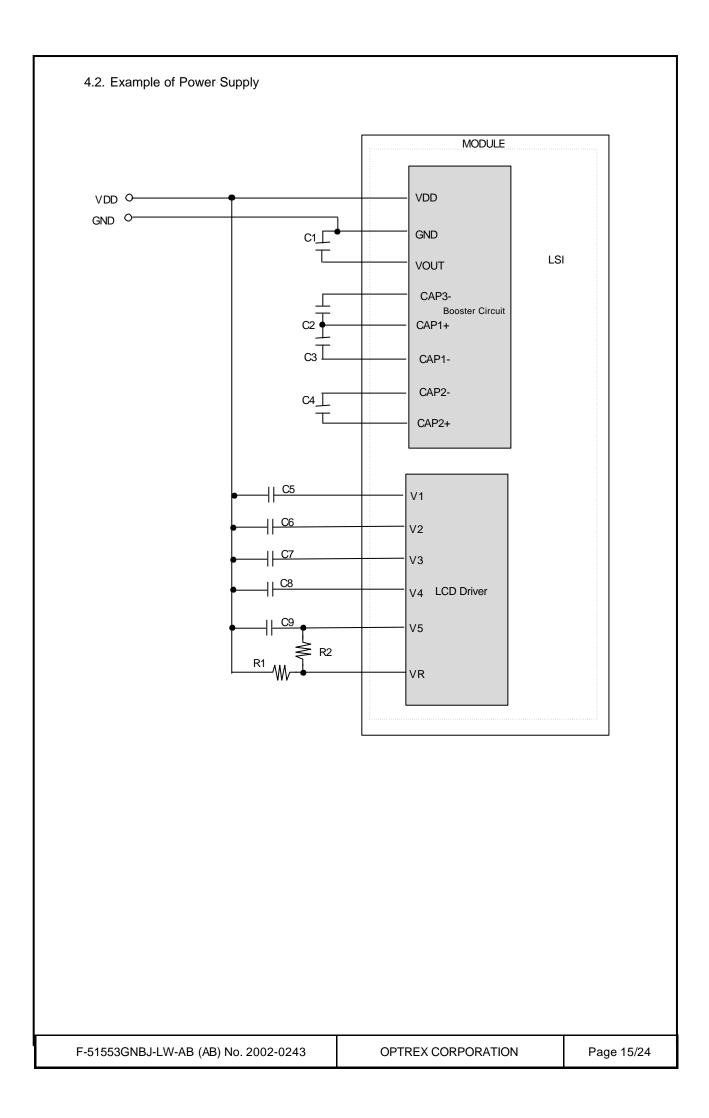


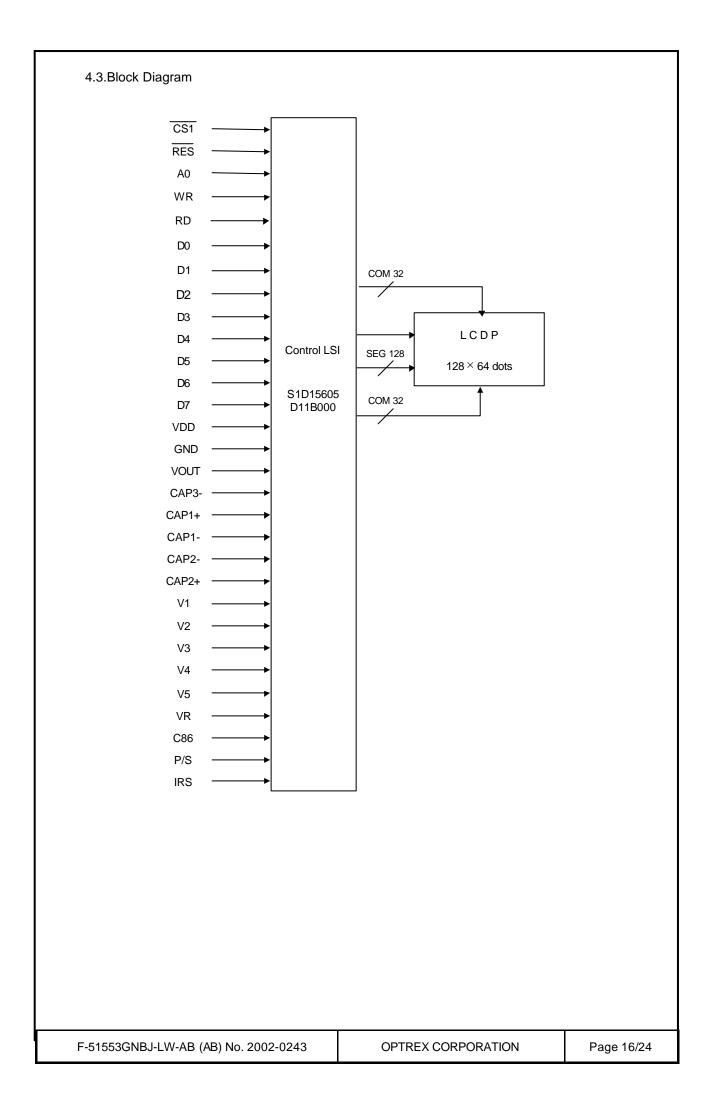
4.I/O Terminal

4.1. Pin Assignment

<u>CN1</u>

No.	Symbol	Function
1	CS1	Chip Select Signal L : Active
2	RES	Reset Signal L : Reset
3	A0	H : D0~D7 are Display Data L : D0~D7 are Instructions
4	WR	Write Signal L : Active
5	RD	Read Signal L : Active
6	D0	Data Bus Line
7	D1	Data Bus Line
8	D2	Data Bus Line
9	D3	Data Bus Line
10	D4	Data Bus Line
11	D5	Data Bus Line
12	D6	Data Bus Line
13	D7	Data Bus Line
14	Vdd	Power Supply for Logic
15	GND	Power Supply (0V, GND)
16	Vout	DC/DC Voltage Converter Output
17	CAP3-	DC/DC Voltage Converter Negative Connection
18	CAP1+	DC/DC Voltage Converter Positive Connection
19	CAP1-	DC/DC Voltage Converter Negative Connection
20	CAP2-	DC/DC Voltage Converter Negative Connection
21	CAP2+	DC/DC Voltage Converter Positive Connection
22	V1	Power Supply for LCD Drive $V_1 = 1/7, V_5$
23	V2	Power Supply for LCD Drive $V_2 = 2/7, V_5$
24	V3	Power Supply for LCD Drive $V_3 = 5/7, V_5$
25	V4	Power Supply for LCD Drive $V_4 = 6/7, V_5$
26	V5	Power Supply for LCD Drive V5, Vout
27	VR	Voltage Adjustment Pin
28	C86	Interface Mode Select Signal H : 68 series L : 80 series
29	P/S	Parallel / Serial Data Select Signal H: Parallel L: Serial
30	IRS	This terminal selects the resistors for the V5 voltage level adjustment.
		IRS="H" :Use the internal resistors
		IRS="H" :Do not use the internal resistors. The V5 voltage
		level is requlated by an external resistive voltage divider attached
		to the VR terminal.





No	change on display and in operati	on under the following test condition.	
Conditic	ns: Unless otherwise specified Temperature: 20±5°C Humidity : 65±5%RH tests will be not conducted	d, tests will be conducted under the following condition during a condition during state.	n.
No.	Parameter	Conditions	Notes
1	High Temperature Operating	70°C±2°C, 96hrs (operation state)	
2	Low Temperature Operating	-20°C±2°C, 96hrs (operation state)	1
3	High Temperature Storage	85°C±2°C, 96hrs	2
4	Low Temperature Storage	-30°C±2°C, 96hrs	1,2
5	Damp Proof Test	40°C±2°C,90~95%RH, 96hrs	1,2
		The function test shall be conducted after 1 hours storage at the normal temperature and humidity after removed from the test chamber.	
7	Shock Test	To be measured after dropping from 60cm high on the concrete surface in packing state.	

Note 2 :The function test shall be conducted after 4 hours storage at the normal Temperature and humidity after removed from the test chamber.

Note 3 :Vibration test will be conducted to the product itself without putting it in a container.

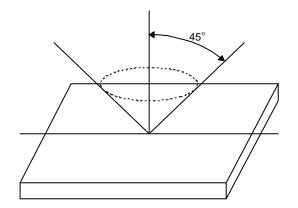
6.Appearance Standards

6.1. Inspection conditions

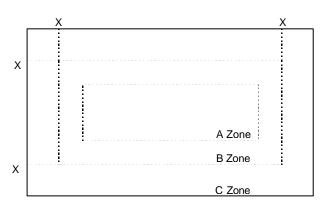
The LCD shall be inspected under 40W white fluorescent light.

The distance between the eyes and the sample shall be more than 30cm.

All directions for inspecting the sample should be within 45° against perpendicular line.



6.2. Definition of applicable Zones



X : Maximum Seal Line

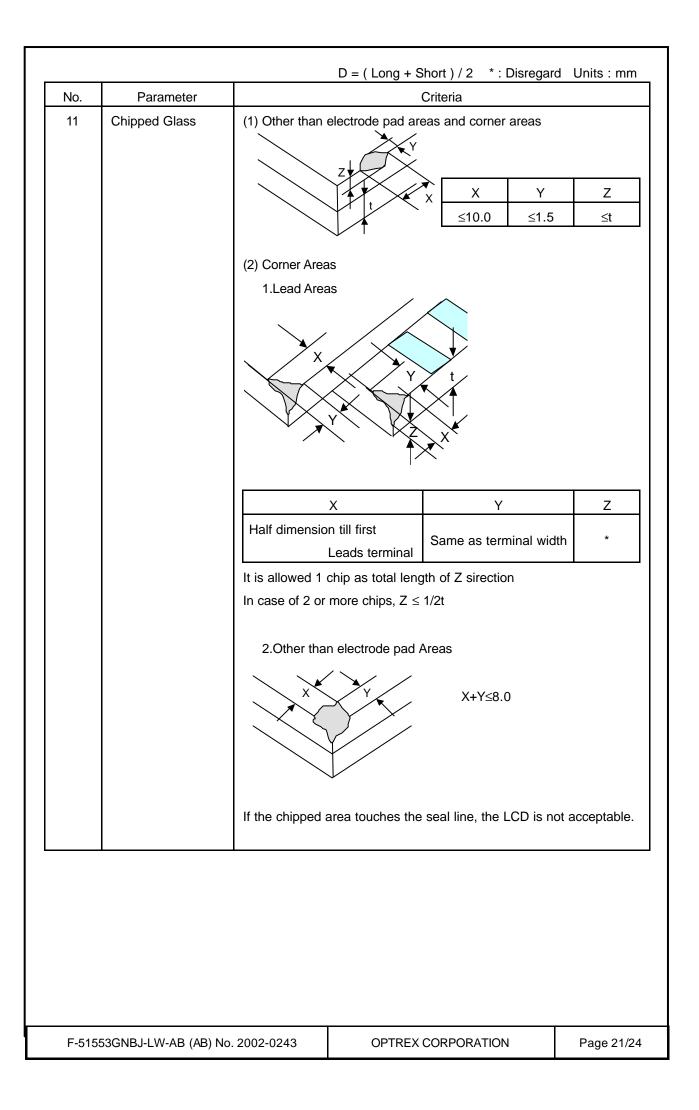
A Zone : Active display area

- B Zone : Out of active display area ~ Maximum seal line
- C Zone : Rest parts

A Zone + B Zone = Validity viewing area

No	Deremeter) / 2 * : Disregar	
No.	Parameter			Criter	ia	
1	The Shape of Dot	(1) Pin Hole				Number
					*	Number
			D ≤ 0	.10		
			0.10 < D ≤ 0.	20	1 pc / dot(only se 5 pcs / cell or les	
		(2) Pattern Shi	ft			
		A B	A − B ←	≤ 0.15		
		(3) Breakage c	or Chips / Defor	mation		
		A	1.Segment Typ	e		
			Dimensio	n	Acceptable	Number
			A ≤ 0.10		*	
			B ≤ 0.15		*	
		B → B	2.Dot Type			
		А	Dimension		Acceptable Nu	mber
			A≤0.10	(Shou	* Id not be connecte	ed to next dot
				1 pc / dot(only segment)or l)or less
		└── <mark>─</mark> ┣	0.10 <a≤0.15< td=""><td colspan="3">5 pcs / cell or less</td></a≤0.15<>	5 pcs / cell or less		
				(Should not be connected		ed to next dot
			B ≤ 0.15		*	
		3.[Defective type e	xtends	over multiple num	bers of dots
			Dimension		Acceptable Nu	mber
			D≤0.10		*	
				-	1 pc / dot(only segment)or less	
			0.10 <d≤0.20< td=""><td colspan="2">5 pcs / cell or less</td></d≤0.20<>	5 pcs / cell or less		
		(Individual dot mus				re 1/2 area
				or mo	ore)	

No.	Parameter	Criteria					
2	Black and	(1) Round Shape					
	White Spots,	Zone		Acce	eptable Numb	ber	
	Foreign Substances	Dimension		А	В	С	
		D ≤ 0.10		*	*	*	
		0.10< D ≤ 0.20		6	6	*	
		0.20<	D ≤ 0.30	4	4	*	
		Individual dot must secure 1/2 area or more.					
		(2) Line Shape					
			Zone	Acc	Acceptable Number		
		Length	Width	A	В	С	
		*	W≤0.03	*	*	*	
		L ≤2.0	0.03 <w≤0.05< td=""><td>5</td><td>5</td><td>*</td></w≤0.05<>	5	5	*	
		L ≤1.0	≤0.10	4	4	*	
		*	0.10 <w< td=""><td>In the san</td><td>ne way (1)</td><td>*</td></w<>	In the san	ne way (1)	*	
		(Refer to "Complex Foreign Substance Defects") Not to be conspicuous defects.					
3 4	Color Variation Air Bubbles	Not to be cons	picuous defects.				
		Not to be cons	picuous defects.	Acc	eptable Numb	per	
	Air Bubbles	Not to be cons		Acco	eptable Numb	per C	
	Air Bubbles (between glass						
	Air Bubbles (between glass	Dimension	Zone	А	В	С	
	Air Bubbles (between glass	Dimension 0.30<	Zone D ≤ 0.30	A *	B *	C *	
	Air Bubbles (between glass	Dimension 0.30< 0.40< No more that	Zone D ≤ 0.30 D ≤ 0.40	A * 3 2	B * * 3	C * *	
	Air Bubbles (between glass	Dimension 0.30< 0.40< No more that (Refer to "Co	Zone $D \le 0.30$ $D \le 0.40$ $D \le 0.60$ m 3pcs as total.	A * 3 2	B * * 3	C * *	
4	Air Bubbles (between glass & polarizer)	Dimension 0.30< 0.40< No more that (Refer to "Co Not to be cons	Zone $D \le 0.30$ $D \le 0.40$ $D \le 0.60$ In 3pcs as total. mplex Foreign Su	A * 3 2 ubstance Def	B * 3 ects")	C * *	
5	Air Bubbles (between glass & polarizer) Polarizer Scratches	Dimension 0.30< 0.40< No more that (Refer to "Co Not to be cons If the stains are not defective.	Zone $D \le 0.30$ $D \le 0.40$ $D \le 0.60$ In 3pcs as total. mplex Foreign Su	A * 3 2 ubstance Def	B * 3 Fects")	C * *	
4 5 6	Air Bubbles (between glass & polarizer) Polarizer Scratches Polarizer Dirts	Dimension 0.30< 0.40< No more that (Refer to "Co Not to be cons If the stains are not defective. Black spots, lin	Zone $D \le 0.30$ $D \le 0.40$ $D \le 0.60$ In 3pcs as total. Implex Foreign Su spicuous defects. The removed easily	A * 3 2 ubstance Def from LCDP s	B * 3 Fects") surface, the m	C * *	
4 5 6	Air Bubbles (between glass & polarizer) Polarizer Scratches Polarizer Dirts Complex Foreign	Dimension 0.30< 0.40< No more that (Refer to "Co Not to be cons If the stains are not defective. Black spots, lin	Zone $D \le 0.30$ $D \le 0.40$ $D \le 0.60$ In 3pcs as total. Implex Foreign Su picuous defects. Premoved easily the shaped foreign er should be 9pc	A * 3 2 ubstance Def from LCDP s	B * 3 Fects") surface, the m	C * *	
4 5 6 7	Air Bubbles (between glass & polarizer) Polarizer Scratches Polarizer Dirts Complex Foreign Substance Defects	Dimension 0.30< 0.40< No more that (Refer to "Co Not to be cons If the stains are not defective. Black spots, lin glass & polariz	Zone $D \le 0.30$ $D \le 0.40$ $D \le 0.60$ In 3pcs as total. Implex Foreign Su picuous defects. Premoved easily the shaped foreign er should be 9pc	A * 3 2 ubstance Def from LCDP s	B * 3 Fects") surface, the m	C * *	



7.Code System of Production Lot		
The production lot of module is specifie	d some of the following.	
Factor		
Factory Factory Production Month Production Year (Lower 2)	/eek (1~5) (1~9, X, Y, Z)	Mon : B~)
8.Type Number		
The type number of module is specified	as follows.	
F-51553GNBJ-LW-AB		
<u>9.Applying Precautions</u> Please contact us when questions and, Specifications arise.	or new problems not specified in this	
F-51553GNBJ-LW-AB (AB) No. 2002-0243	OPTREX CORPORATION	Page 22/24

10.Precautions Relating Product Handling

The Following precautions will guide you in handling our product correctly.

- 1) Liquid crystal display devices
- 1. The liquid crystal display device panel used in the liquid crystal display module is made of plate glass. Avoid any strong mechanical shock. Should the glass break handle it with care.
- 2. The polarizer adhering to the surface of the LCD is made of a soft material. Guard against scratching it.

2) Care of the liquid crystal display module against static electricity discharge.

- 1. When working with the module, be sure to ground your body and any electrical equipment you may be using. We strongly recommend the use of anti static mats (made of rubber), to protect work tables against the hazards of electrical shock.
- 2. Avoid the use of work clothing made of synthetic fibers. We recommend cotton clothing or other conductivity-treated fibers.
- 3. Slowly and carefully remove the protective film from the LCD module, since this operation can generate static electricity.

3) When the LCD module alone must be stored for long periods of time:

- 1. Protect the modules from high temperature and humidity.
- 2. Keep the modules out of direct sunlight or direct exposure to ultraviolet rays.
- 3. Protect the modules from excessive external forces.
- 4) Use the module with a power supply that is equipped with an overcurrent protector circuit, since the module is not provided with this protective feature.
- 5) Do not ingest the LCD fluid itself should it leak out of a damaged LCD module. Should hands or clothing come in contact with LCD fluid, wash immediately with soap.
- 6) Conductivity is not guaranteed for models that use metal holders where solder connections between the metal holder and the PCB are not used. Please contact us to discuss appropriate ways to assure conductivity.

7) For models which use CFL:

- 1. High voltage of 1000V or greater is applied to the CFL cable connector area. Care should be taken not to touch connection areas to avoid burns.
- 2. Protect CFL cables from rubbing against the unit and thus causing the wire jacket to become worn.
- 3. The use of CFLs for extended periods of time at low temperatures will significantly shorten their service life.

8) For models which use touch panels:

- 1. Do not stack up modules since they can be damaged by components on neighboring modules.
- 2. Do not place heavy objects on top of the product. This could cause glass breakage.

9) For models which use COG,TAB,or COF:

- 1. The mechanical strength of the product is low since the IC chip faces out unprotected from the rear. Be sure to protect the rear of the IC chip from external forces.
- 2. Given the fact that the rear of the IC chip is left exposed, in order to protect the unit from electrical damage, avoid installation configurations in which the rear of the IC chip runs the risk of making any electrical contact.

- 10) Models which use flexible cable, heat seal, or TAB:
 - 1. In order to maintain reliability, do not touch or hold by the connector area.
- 2. Avoid any bending, pulling, or other excessive force, which can result in broken connections.
- have an adverse effect on connecting parts (LCD panel-TCP / HEAT SEAL / FPC / etc., PCB-TCP / HEAT SEAL / FPC etc., TCP-HEAT SEAL, TCP-FPC, HEAT SEAL-FPC, etc.,) depending on its materials.
 Please check and evaluate these materials carefully before use.
- 12) In case of acrylic plate is attached to front side of LCD panel, cloudiness (very small cracks) can occur on acrylic plate, being influenced by some components generated from polarizer film..

Please check and evaluate those acrylic materials carefully before use.

11.Warranty

This product has been manufactured to your company's specifications as a part for use in your company's general electronic products. It is guaranteed to perform according to delivery specifications. For any other use apart from general electronic equipment, we cannot take responsibility if the product is used in medical devices, nuclear power control equipment, aerospace equipment, fire and security systems, or any other applications in which there is a direct risk to human life and where extremely high levels of reliability are required. If the product is to be used in any of the above applications, we will need to enter into a separate product liability agreement.

- 1. We cannot accept responsibility for any defect, which may arise from additional manufacturing of the product (including disassembly and reassembly), after product delivery.
- 2. We cannot accept responsibility for any defect, which may arise after the application of strong external force to the product.
- 3. We cannot accept responsibility for any defect, which may arise due to the application of static electricity after the product has passed your company's acceptance inspection procedures.
- 4. When the product is in CFL models, CFL service life and brightness will vary According to the performance of the inverter used, leaks, etc. We cannot accept responsibility for product performance, reliability, or defect, which may arise.
- 5. We cannot accept responsibility for intellectual property of a third party, which may arise through the application of our product to your assembly with exception to those issues relating directly to the structure or method of manufacturing of our product.
- Optrex will not be held responsible for any quality guarantee issue for defect products judged as Optrex-origin longer than 2 (two) years from Optrex production or 1(one) year from Optrex, Optrex America, Optrex Europe, Display LC delivery which ever comes later.